

# International IOR Rectifier IRFK4HE50, IRFK4JE50

## Isolated Base Power HEX-pak™ Assembly - Parallel Chip Configuration

- High Current Capability.
- UL recognised E78996.
- Electrically Isolated Base Plate.
- Easy Assembly into Equipment.

### Description

The HEX-pak™ utilises the well-proven HEXFET™ die, combining low on-state resistance with high transconductance. These superior technology die are assembled by state of the art techniques into the TO-240 package, featuring 2.5kV rms isolation and solid M5 screw connections. The small footprint means the package is highly suited to power applications where space is a premium. Available in two versions, IRFK.H... for fast switching and IRFK.J... for oscillation sensitive applications.

$$V_{DS} = 800V$$

$$R_{DS(on)} = 300m\Omega$$

$$I_D = 26A$$

### Absolute Maximum Rating

	Parameter	Max.	Units
$I_D @ T_C=25^\circ C$	Continuous Drain Current	26	A
$I_D @ T_C=100^\circ C$	Continuous Drain Current	16	A
$I_{DM}$	Pulse Drain Current	104	A ①
$P_D @ T_C=25^\circ C$	Maximum Power Dissipation	500	W
$V_{GS}$	Gate-to-Source Voltage	20	V
$V_{INS}$	R.M.S. Isolation Voltage, circuit to base	2.5	kV
$T_J$	Operating Junction Temperature Range	-40 to 150	$^\circ C$
$T_{STG}$	Storage Temperature Range	-40 to 150	$^\circ C$

### Thermal and Mechanical Specifications

	Parameter	Min.	Typ.	Max.	Units
$R_{thJC}$	Junction-to-Case	-	-	0.25	K/W ②
$R_{thCS}$	Case-to-Sink, smooth & greased surface	-	0.1	-	K/W
T	Mounting Torque +10%				③
	HEXpak to Heatsink	-	5	-	Nm
	Busbar to HEXpak	-	3	-	Nm
wt	Approximate Weight	-	140	-	g
		-	5	-	oz

#### Notes:

- ① - Repetitive Rating: Pulse width limited by maximum junction temperature see figure 8.
- ② - Per Module.
- ③ - A mounting compound is recommended and the torque should be rechecked after a period of three hours to allow for the spread of the compound.

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## Electrical Characteristics @ T<sub>J</sub> = 25°C (Unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Test Conditions	
B <sub>V</sub> DSS	Drain-to-Source Breakdown voltage	800	-	-	V	V <sub>GS</sub> =0V, I <sub>D</sub> =1.0mA	
R <sub>DS(on)</sub>	Static Drain-to-Source On-State Resistance	-	240	300	mΩ	V <sub>GS</sub> =10V, I <sub>D</sub> =8A	
I <sub>D(on)</sub>	On-State Drain Current	26	-	-	A	V <sub>DS</sub> > I <sub>D(on)</sub> × R <sub>DS(on)</sub> max, V <sub>GS</sub> =10V	
V <sub>GS(th)</sub>	Gate Threshold Voltage	2.0	-	4.0	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =1.0mA	
g <sub>fs</sub>	Forward Transconductance ③	26	35	-	S	V <sub>DS</sub> > 50V, I <sub>D</sub> =16A	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	-	-	1.0	mA	V <sub>DS</sub> =V <sub>GS</sub> max, V <sub>GS</sub> =0V	
		-	-	4.0	mA	V <sub>GS</sub> =10V, T <sub>C</sub> =125°C, V <sub>DS</sub> =V <sub>GS</sub> max × 0.8	
I <sub>GSS</sub>	Gate-to-Source Leakage Forward	-	-	400	nA	V <sub>GS</sub> =20V	
I <sub>GSS</sub>	Gate-to-Source Leakage Reverse	-	-	-400	nA	V <sub>GS</sub> =-20V	
Q <sub>g</sub>	Total Gate Charge	-	580	760	nC	I <sub>D</sub> =26A, V <sub>GS</sub> =10V,	
Q <sub>gs</sub>	Gate-to-Source Charge	-	40	60	nC	V <sub>DS</sub> =V <sub>DS</sub> max × 0.8	
Q <sub>gd</sub>	Gate-to-Drain ("Miller") Charge	-	288	440	nC		
t <sub>d(on)</sub>	Turn-on Delay Time	IRFK4HE50	-	70	-	ns	V <sub>DD</sub> =400V, I <sub>D</sub> =16A,
		IRFK4JE50	-	80	-	ns	
t <sub>r</sub>	Rise Time	IRFK4HE50	-	55	-	ns	V <sub>GS</sub> =10V,
		IRFK4JE50	-	70	-	ns	
t <sub>d(off)</sub>	Turn-off Delay Time	IRFK4HE50	-	350	-	ns	R <sub>SOURCE</sub> =3.3Ω
		IRFK4JE50	-	470	-	ns	
t <sub>f</sub>	Fall Time	IRFK4HE50	-	60	-	ns	
		IRFK4JE50	-	100	-	ns	
L <sub>DS</sub>	Drain-to-Source Inductance	-	18	-	nH		
C <sub>iss</sub>	Input Capacitance	-	10.5	-	nF	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V,	
C <sub>oss</sub>	Output Capacitance	-	2.5	-	nF	f=1.0MHz	
C <sub>rss</sub>	Reverse Transfer Capacitance	-	2.0	-	nF		
V <sub>INS</sub>	R.M.S. Isolation Voltage	2.5	-	-	kV	Circuit to Base	

## Source-Drain Diode Ratings and Characteristics

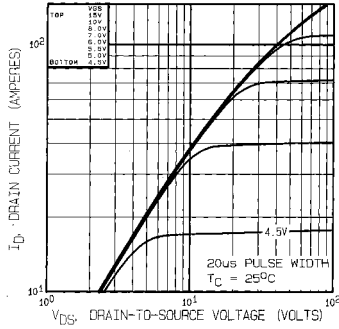
	Parameter	Min.	Typ.	Max.	Units	Test Conditions
I <sub>S</sub>	Continuous Source Current (Body Diode)	-	-	26	A	
I <sub>SM</sub>	Pulsed Source Current (Body Diode)	-	-	90	A	
V <sub>SD</sub>	Diode Forward Voltage	-	-	1.8	V	V <sub>GS</sub> =0V, I <sub>S</sub> =26A, T <sub>C</sub> =25°C
t <sub>rr</sub>	Reverse Recovery Time	370	770	1600	ns	di/dt=400A/μs, T <sub>J</sub> =150°C
Q <sub>rr</sub>	Reverse Recovered Charge	12.0	26.0	52.0	μC	I <sub>S</sub> =26A

### Notes:

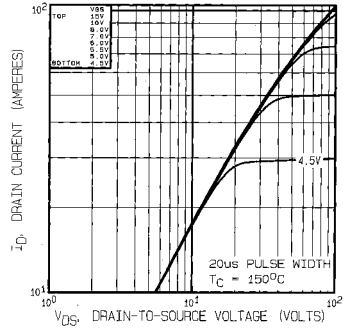
③ - Pulse Width ≤ 300μs; Duty cycle ≤ 2%.



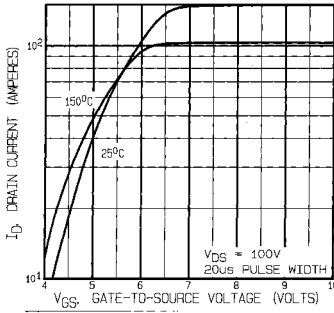
# IRFK4HE50, IRFK4JE50



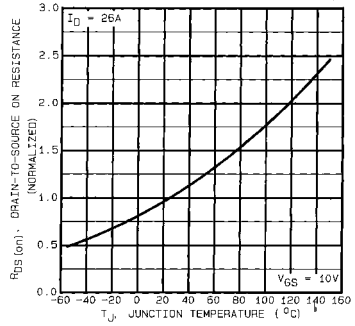
**Fig 1. Typical Output Characteristics,**  
 $T_c=25^\circ\text{C}$



**Fig 2. Typical Output Characteristics,**  
 $T_c=150^\circ\text{C}$

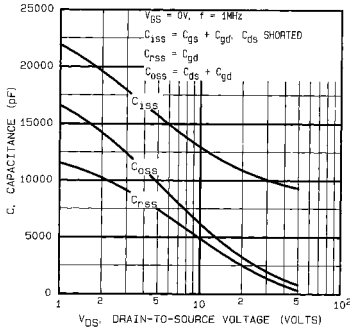


**Fig 3. Typical Transfer Characteristics**

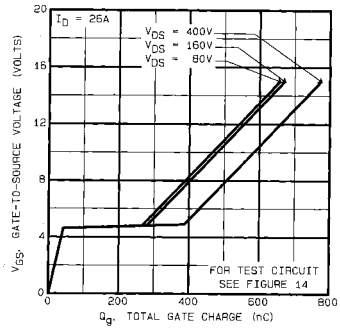


**Fig 4. Normalized On-Resistance Vs. Temperature**

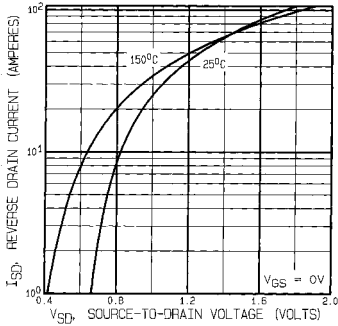
# IRFK4HE50, IRFK4JE50



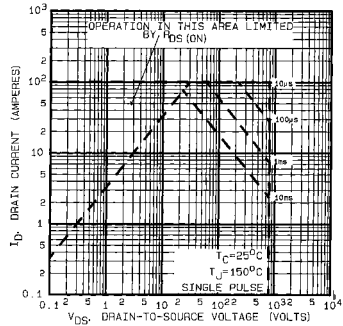
**Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage**



**Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage**



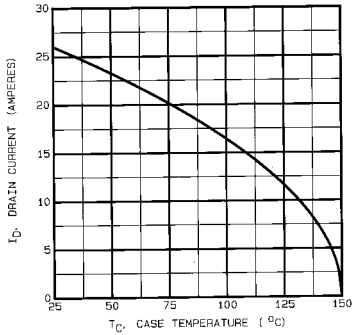
**Fig 7. Typical Source-Drain Diode Forward Voltage**



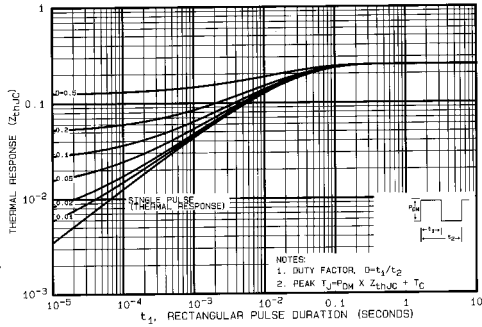
**Fig 8. Maximum Safe Operating Area**



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**Fig 9.** Maximum Drain Current Vs. Case Temperature



**Fig 10.** Maximum Effective Transient Thermal Impedance, Junction-to-Case

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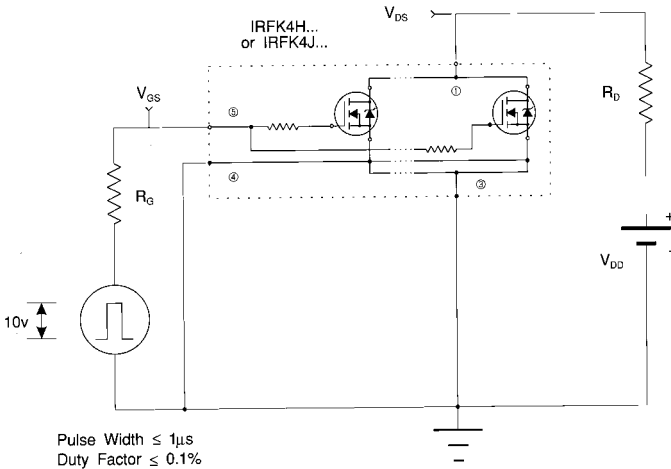


Fig 11a. Switching Time Test Circuit

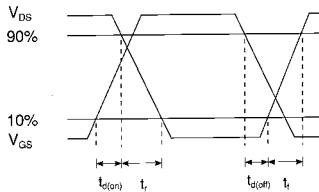
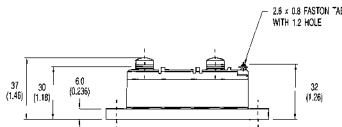
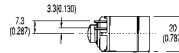
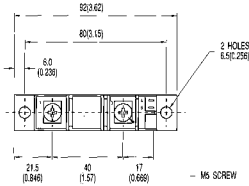
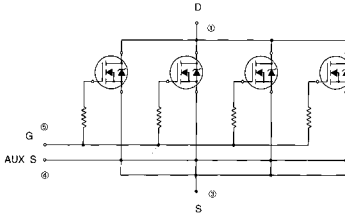


Fig 11b. Switching Time Waveforms



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## Circuit Configuration and Outline



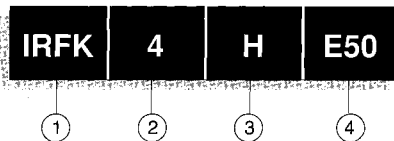
NOTE:  
DEVICE IS SUPPLIED WITH  
AUXILIARY LEADS 200(7.87) LONG

All dimensions in millimetres (inches)

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## Part Numbering



1. - HEX-pak Module.
2. - Number of HEXFETs in parallel.
3. - H - Fast switching.  
- J - Oscillation resistant for sensitive applications.
4. - Voltage code:-
  - 054 - 60V
  - 150 - 100V
  - 250 - 200V
  - 350 - 400V
  - 450 - 500V
  - C50 - 600V
  - E50 - 800V

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MJW/1/82